

**Electronic Patent Application Fee Transmittal**

<b>Application Number:</b>	10583525			
<b>Filing Date:</b>	16-Jun-2006			
<b>Title of Invention:</b>	Semiconductor package with integrated heatsink and electromagnetic shield			
<b>First Named Inventor/Applicant Name:</b>	Andrew Holland			
<b>Filer:</b>	John S. Sopko/Mary Farischon			
<b>Attorney Docket Number:</b>	1662-2 PCT/US			
Filed as Small Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	2615	6	26	156
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	2252	1	245	245
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>401</b>